PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yukie SAITOU	04/08/2013
Wataru FUJIKAWA	04/08/2013
Jun SHIRAKAMI	04/08/2013

RECEIVING PARTY DATA

Name: DIC Corporation			
Street Address: 35-58, Sakashita 3-chome, Itabashi-ku			
City: Tokyo State/Country: JAPAN			
		Postal Code:	174-8520

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13881254

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	086746-0050
NAME OF SUBMITTER:	Hiroko Lavietes
Signature:	/Hiroko Lavietes/

REEL: 030278 FRAME: 0271

PATENT

Date:	04/24/2013
Total Attachments: 3 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif	

PATENT REEL: 030278 FRAME: 0272

RECORDATION FORM COVER SHEET							
PATENTS	PATENTS ONLY						
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.							
Name of conveying party(ies):	1. Name of conveying party(ies): 2. Name and address of receiving party(ies)						
Yukie SAITOU (04/08/2013), Wataru FUJIKAWA (04/08/2013), and Jun SHIRAKAMI (04/08/2013)	Name: DIC Corporation						
Additional name(s) of conveying party(ies) attached?	Internal Address: Street Address:						
3. Nature of conveyance/Execution Date(s):	1 -						
Execution Date(s): in parentheses after inventor name	35-58, Sakashita 3-chome, Itabashi-ku Tokyo 174-8520 JAPAN						
X Assignment Merger Change of Name							
Security Agreement Joint Research Agreement	City:						
Government Interest Assignment	State:						
Executive Order 9424, Confirmatory License	Country: Zip:						
Other	Additional name(s) & address(es) Yes X No attached?						
A. Patent Application No.(s)	ument serves as an Oath/Declaration (37 CFR 1.63). B. Patent No.(s)						
Additional numbers attached?	Yes X No						
Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:						
Name: Sarika Singh MCDERMOTT WILL & EMERY LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$						
Internal Address: Atty. Dkt.: 086746-0050							
Street Address: 340 Madison Avenue	X Authorized to be charged to deposit account						
!	Enclosed						
	None required (government interest not affecting title)						
City: New York	8. Payment Information						
State: NY Zip: 10173							
Phone Number: (212) 547-5357							
Fax Number: (212) 547-5444	Deposit Account Number 50-0417						
Email Address: mweipdocket@mwe.com	Authorized User Name Sarika Singh						
9. Signature: Janiba Jinth	April 24, 2013						
Signature	Date						
Sarika Singh - L0614	Total number of pages including cover sheet, attachments, and documents: 3						
Name of Person Signing							
Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450							

Docket No.: 086746-0050

ASSIGNMENT

In	consideration	of the	premises	and	other	good	and	valuable	consideration	ıin
hand paid,	the receipt an	d suffici	iency of v	vhich	is her	eby a	ckno	wledged,	the undersign	ed,

(1)	Yukie SAITOU	(4)
(2)	Wataru FUJIKAWA	(5)
(3)	Jun SHIRAKAMI	(6)

who have made a certain new and useful invention, hereby sell, assign and transfer unto

DIC Corporation

a Corporation organized under the law of Japan, located at 35-58, Sakashita 3-chome, Itabashi-ku, Tokyo 174-8520 JAPAN

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

RESIN COMPOSITION FOR FORMING RECEIVING LAYER AND RECEIVING SUBSTRATE, PRINTED MATTER, CONDUCTIVE PATTERN, AND ELECTRIC CIRCUIT PRODUCED BY USING THE RESIN COMPOSITION

(a)	for which	an	international	patent	application	n was	filed	on	August	t 28.	2012,	and
iden	tified by Po	<u>CT/.</u>	JP2012/07168	$3\overline{3}$, which	ch claims	priorit	y to Ja	apar	iese Pat	tent .	Applica	ation
			iled on Septer				_	_				

ĺ	'n)	for which an applic	ation for United State	s Letters Patent was	executed on

and the undersigned hereby authorize and request the United States Commissioner for Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors,

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assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
Yukie Parou	Apr. 8, 2013
Name: Yukie SAITOU	
Watam Fujikan Name: Wataru FUJIKAWA	Apr. 8, 2013
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Jun Shrakami Name: Jun SHIRAKAMI	Apr. 8, 2013
Name: Jun SHIRAKAMI	·
Name:	
Name:	
Name:	
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